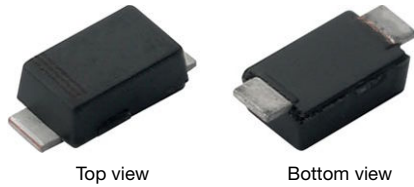


# Surface Mount Trench MOS Barrier Schottky Rectifiers

## TMBS® eSMP® Series



Top view

Bottom view

### SMF (DO-219AB)

Cathode Anode

## DESIGN SUPPORT TOOLS

[click logo to get started](#)


PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	1.0 A
$V_{RRM}$	100 V
$I_{FSM}$	30 A
$V_F$ at $I_F = 1$ A ( $T_A = 125$ °C)	0.59 V
$T_J$ max.	175 °C
Package	SMF (DO-219AB)
Circuit configuration	Single

## FEATURES

- Trench MOS Schottky technology
- Low profile package
- Ideal for automated placement
- Low forward voltage drop, low power losses
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS  
COMPLIANT  
HALOGEN  
FREE**

## TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

## MECHANICAL DATA

**Case:** SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

**Polarity:** color band denotes the cathode end

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)			
PARAMETER	SYMBOL	V1FM10	UNIT
Device marking code		1MB	
Maximum repetitive peak reverse voltage	$V_{RRM}$	100	V
Maximum average forward rectified current (fig.1)	$I_{F(AV)}$ <sup>(1)</sup>	1.0	A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	$I_{FSM}$	30	A
Operating junction temperature range	$T_J$ <sup>(2)</sup>	-40 to +175	°C
Storage temperature range	$T_{STG}$	-55 to +175	

## Notes

(1) Free air, mounted on FR4 PCB, 2 oz. standard footprint

(2) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$



ELECTRICAL CHARACTERISTICS ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 0.5\text{ A}$	$T_A = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	0.57	-	V
	$I_F = 1.0\text{ A}$			0.69	0.77	
	$I_F = 0.5\text{ A}$	$T_A = 125\text{ }^\circ\text{C}$		0.49	-	
	$I_F = 1.0\text{ A}$			0.59	0.67	
Reverse current	$V_R = 70\text{ V}$	$T_A = 25\text{ }^\circ\text{C}$	$I_R^{(2)}$	0.20	-	$\mu\text{A}$
		$T_A = 125\text{ }^\circ\text{C}$		150	-	
	$V_R = 100\text{ V}$	$T_A = 25\text{ }^\circ\text{C}$		-	50	
		$T_A = 125\text{ }^\circ\text{C}$		250	1500	
Typical junction capacitance	4.0 V, 1 MHz		$C_J$	95	-	pF

**Notes**

- (1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle  
(2) Pulse test: Pulse width  $\leq 5\text{ ms}$

THERMAL CHARACTERISTICS ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	V1FM10	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)(2)}$	125	$^\circ\text{C/W}$
	$R_{\theta JM}^{(2)}$	30	

**Notes**

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$   
(2) Device mounted on FR4 PCB, 2 oz. standard footprint, thermal resistance  $R_{\theta JA}$  – junction-to-ambient; thermal resistance  $R_{\theta JM}$  – junction-to-mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V1FM10-M3/H	0.015	H	3000	7" diameter plastic tape and reel
V1FM10-M3/I	0.015	I	10 000	13" diameter plastic tape and reel
V1FM10HM3/H <sup>(1)</sup>	0.015	H	3000	7" diameter plastic tape and reel
V1FM10HM3/I <sup>(1)</sup>	0.015	I	10 000	13" diameter plastic tape and reel

**Note**

- (1) AEC-Q101 qualified

**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^\circ\text{C}$  unless otherwise noted)

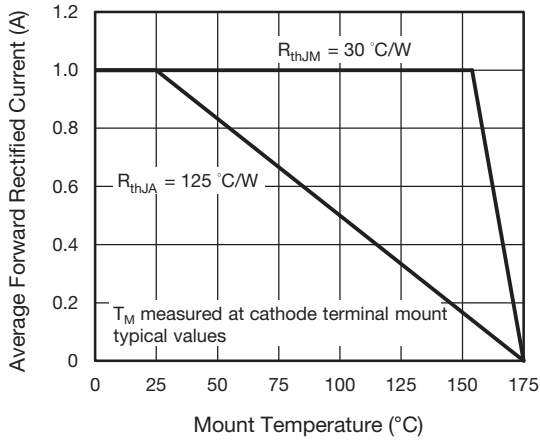


Fig. 1 - Maximum Forward Current Derating Curve

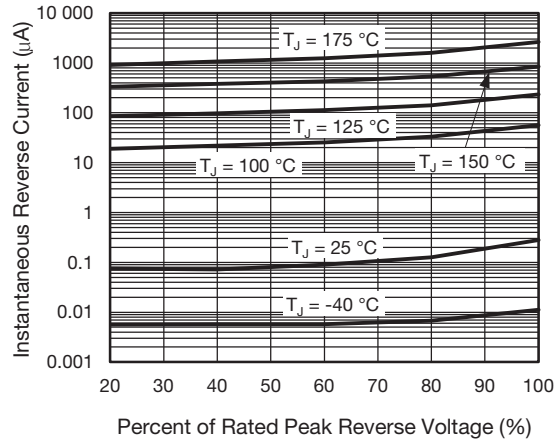


Fig. 4 - Typical Reverse Leakage Characteristics

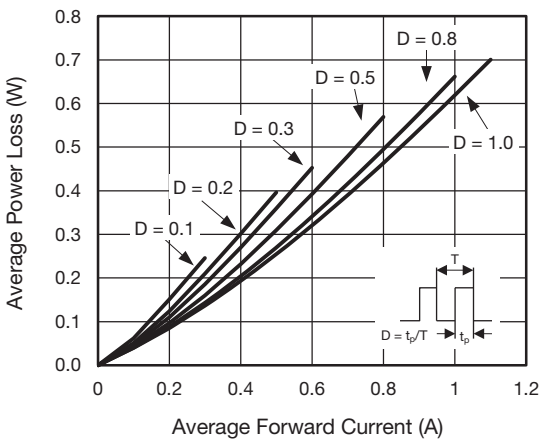


Fig. 2 - Average Power Loss Characteristics

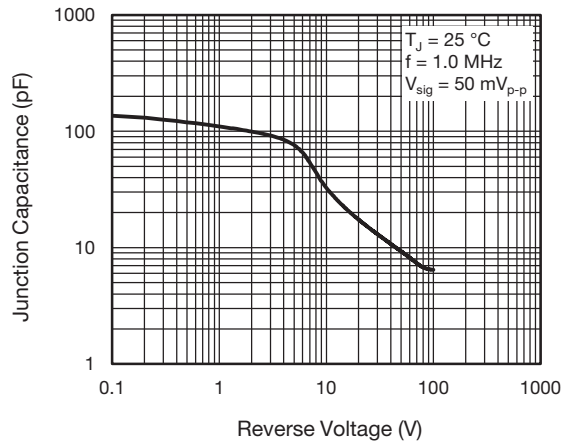


Fig. 5 - Typical Junction Capacitance

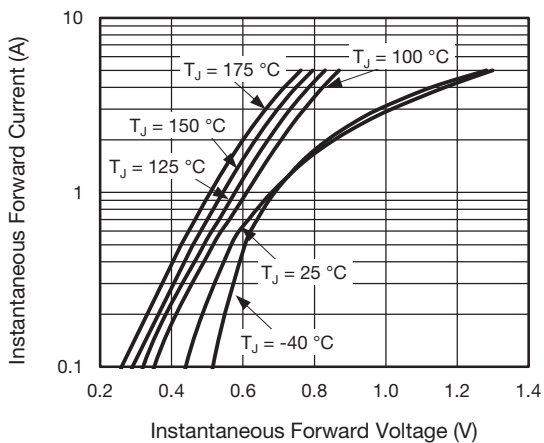


Fig. 3 - Typical Instantaneous Forward Characteristics

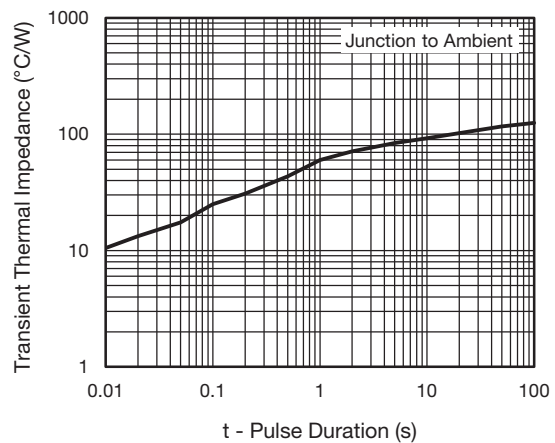
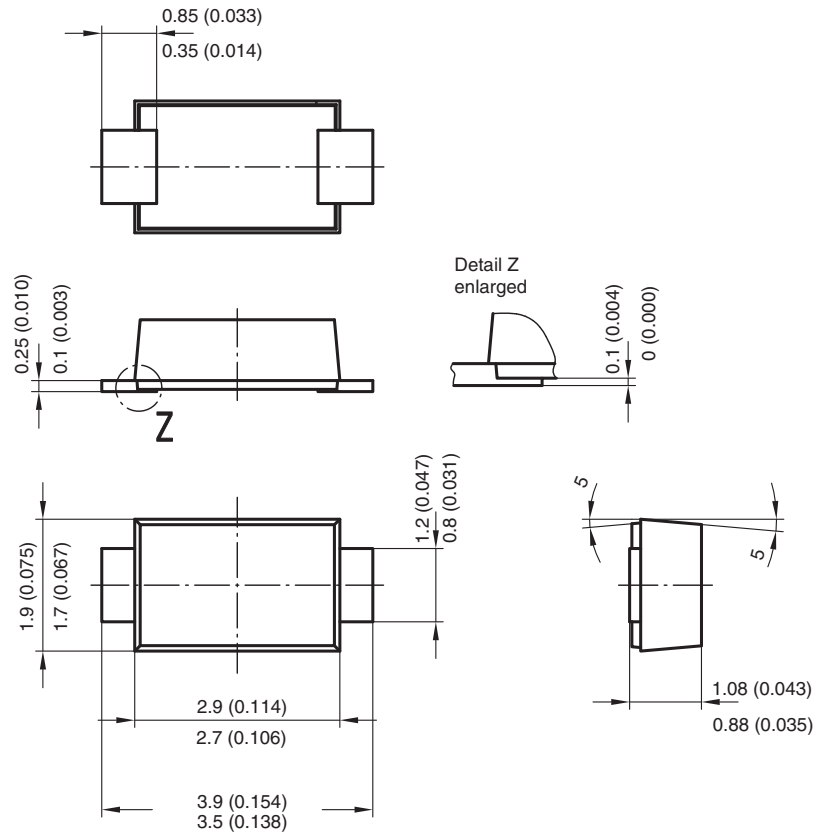
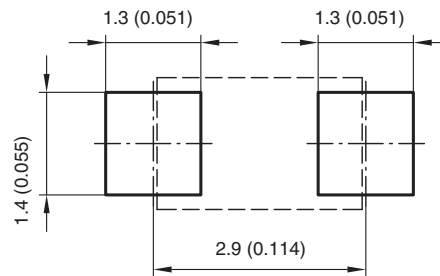


Fig. 6 - Typical Transient Thermal Impedance

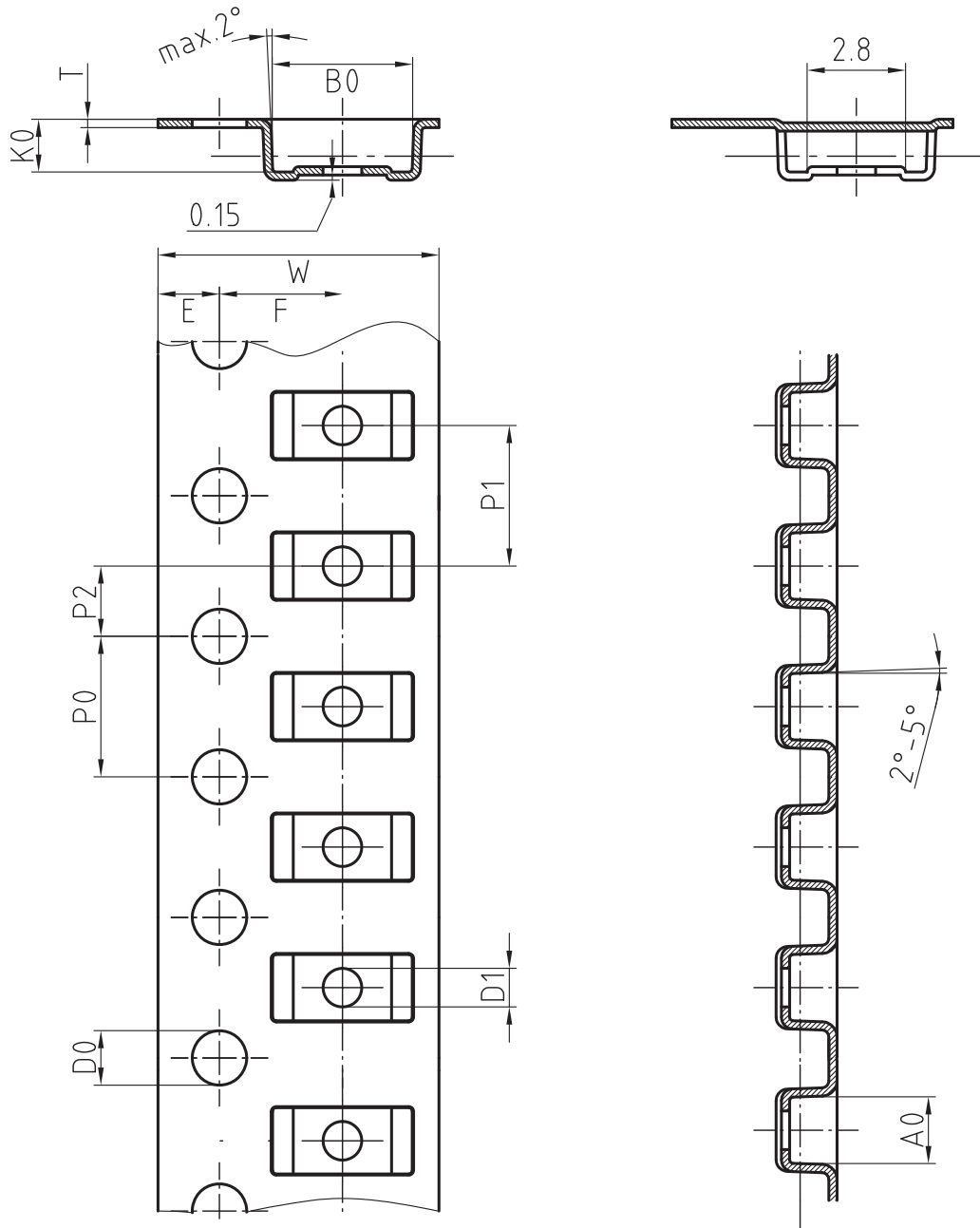
**PACKAGE OUTLINE DIMENSIONS** in millimeters (inches)



Foot print recommendation:



Created - Date: 15. February 2005  
 Rev. 3 - Date: 13. March 2007  
 Document no.: S8-V-3915.01-001 (4)  
 17247

**BLISTERTAPE DIMENSIONS** in millimeters: **SMF (DO-219AB)**


Mat:	A0	B0	K0	W	T	P0	P2	P1	D0	D1	E	F
PS	1.9	4.0	1.5	8.0	0.235	4.0	2.0	4.0	1.5	1	1.75	3.5

Document-No.: S8-V-3717.02-001 (3)

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